

May 29, 2024

Description

Measurements

Carat Weight

Color Grade

Clarity Grade

Cut Grade

Polish

Symmetry

Fluorescence

Inscription(s)

treatment.

Type II

**GRADING RESULTS** 

IGI Report Number

Shape and Cutting Style

ADDITIONAL GRADING INFORMATION

Comments: As Grown - No indication of post-growth

This Laboratory Grown Diamond was created by High

Pressure High Temperature (HPHT) growth process.

GEMOLOGICAL INSTITUTE

## **ELECTRONIC COPY**

## LABORATORY GROWN DIAMOND REPORT

#### 55% 33.9° Medium 15% (Faceted) $\checkmark$ 61.3% 40.7° 43%

LG633454699

Report verification at igi.org

Pointed

### **CLARITY CHARACTERISTICS**

PROPORTIONS

LG633454699

1.06 CARAT

D

SI 1

IDEAL

EXCELLENT

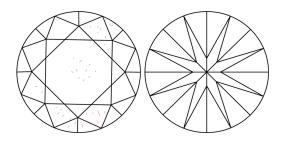
EXCELLENT NONE

1/G1 LG633454699

ROUND BRILLIANT

6.56 - 6.61 X 4.03 MM

LABORATORY GROWN DIAMOND



#### **KEY TO SYMBOLS**

Red symbols indicate internal characteristics. Green symbols indicate external characteristics.

1691 LG633454699

Sample Image Used

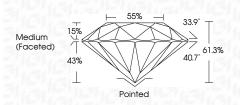
## COLOR

DEF	GHIJ	Faint	Very Light	Light
CLARITY				
IF	VVS <sup>1-2</sup>	VS <sup>1-2</sup>	SI <sup>1-2</sup>	1-3
Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included



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IGI Report Number	LG633454699
Description	LABORATORY GROWN DIAMOND
Shape and Cutting S	Style ROUND BRILLIANT
Measurements	6.56 - 6.61 X 4.03 MM
GRADING RESULTS	
Carat Weight	1.06 CARAT
Color Grade	D
Clarity Grade	SI 1
Cut Grade	IDEAL



#### ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT		
Symmetry	EXCELLENT		
Fluorescence	NONE		
Inscription(s)	位到 LG633454699		
Comments: As Grown - No indication of post-growth treatment. This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II			





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